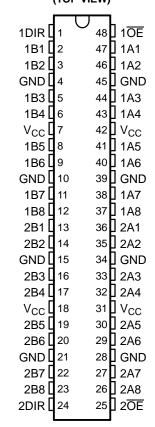
# SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300G-MARCH 1994-REVISED JANUARY 2006

#### **FEATURES**

- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical  $V_{OLP}$  (Output Ground Bounce) <1 V at  $V_{CC}$  = 5 V,  $T_A$  = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (-32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- Latch-Up Performance Exceeds 500 mA Per JESD 70
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Includes Plastic Thin Very Small-Outline (DGV), Shrink Small-Outline (DL), and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic (WD) Flat Package Using 25-mil Center-to-Center Spacings

SN54ABT16245A... WD PACKAGE SN74ABT16245A... DGG, DGV, OR DL PACKAGE (TOP VIEW)



#### **DESCRIPTION**

The 'ABT16245A devices are 16-bit noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

These devices can be used as two 8-bit transceviers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so that the buses are effectively isolated.

When  $V_{CC}$  is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impendance state above 2.1 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16245A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16245A is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

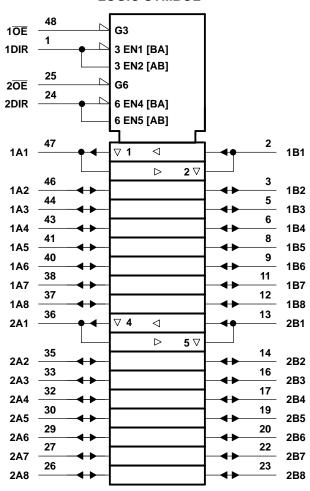
Widebus, EPIC-IIB are trademarks of Texas Instruments.



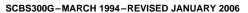
# FUNCTION TABLE (EACH 8-BIT SECTION)

| INP | UTS | OPERATION       |
|-----|-----|-----------------|
| ŌĒ  | DIR | OPERATION       |
| L   | L   | B data to A bus |
| L   | Н   | A data to B bus |
| Н   | Χ   | Isolation       |

# LOGIC SYMBOL(1)

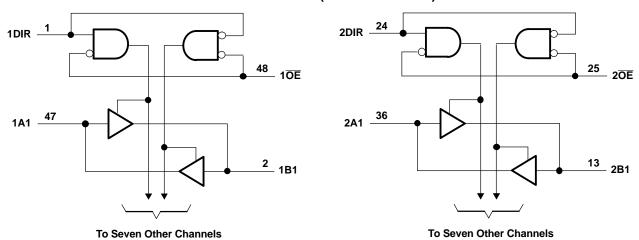


(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.





## **LOGIC DIAGRAM (POSITIVE LOGIC)**



# Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

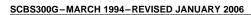
|                  |  |                    | MIN | MAX | UNIT |  |
|------------------|--|--------------------|-----|-----|------|--|
| $V_{CC}$         | Supply voltage range                               | -0.5               | 7   | ٧   |      |  |
| VI               | Input voltage range (except I/O ports)(2)          | -0.5               | 7   | V   |      |  |
| Vo               | Voltage range applied to any output in the high of | -0.5               | 5.5 | V   |      |  |
|                  | Compart into any system tip the law state          | SN54ABT16245A      |     | 96  | A    |  |
| IO               | Current into any output in the low state           | SN74ABT16245A      |     | 128 | mA   |  |
| I <sub>IK</sub>  | Input clamp current                                | V <sub>I</sub> < 0 |     | -18 | mA   |  |
| I <sub>OK</sub>  | Output clamp current                               | V <sub>O</sub> < 0 |     | -50 | mA   |  |
|                  |  | DGG package        |     | 89  |      |  |
| $\theta_{JA}$    | Package thermal impedance (3)                      | DGV package        |     | 93  | °C/W |  |
|                  |  | DL package         |     | 94  |      |  |
| T <sub>stg</sub> | Storage temperature range                          |                    | -65 | 150 | °C   |  |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>(2)</sup> The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>(3)</sup> The package thermal impedance is calculated in accordance with JESD 51.

# SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS





# Recommended Operating Conditions<sup>(1)</sup>

|                          |                                    |                 | SN54ABT  | 16245A | SN74ABT  | 16245A | UNIT |  |
|--------------------------|------------------------------------|-----------------|----------|--------|----------|--------|------|--|
|                          |                                    |                 | MIN      | MAX    | MIN      | MAX    | ONIT |  |
| V <sub>CC</sub>          | Supply voltage                     | 4.5             | 5.5      | 4.5    | 5.5      | V      |      |  |
| V <sub>IH</sub>          | High-level input voltage           | 2               |          | 2      |          | V      |      |  |
| $V_{IL}$                 | Low-level input voltage            |                 | 0.8      |        | 0.8      | V      |      |  |
| VI                       | Input voltage                      | 0               | $V_{CC}$ | 0      | $V_{CC}$ | V      |      |  |
| I <sub>OH</sub>          | High-level output current          |                 |          | -24    |          | -32    | mA   |  |
| I <sub>OL</sub>          | Low-level output current           |                 |          | 48     |          | 64     | mA   |  |
| Δt/Δν                    | Input transition rise or fall rate | Outputs enabled |          | 10     |          | 10     | ns/V |  |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 |                 |          |        | 200      |        | μs/V |  |
| T <sub>A</sub>           | Operating free-air temperature     | -55             | 125      | -40    | 85       | °C     |      |  |

<sup>(1)</sup> All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SCBS300G-MARCH 1994-REVISED JANUARY 2006

#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| DAD                             | AMETER   | TEST CONDITIONS  |   |      | Γ <sub>A</sub> = 25°0 | ;                  | SN54ABT            | 16245A             | SN74ABT           |                    |      |
|---------------------------------|--|--|---|------|-----------------------|--------------------|--------------------|--------------------|-------------------|--------------------|------|
| PARA                            | AMETER   | TEST CO  | SNOTHONS                                | MIN  | TYP <sup>(1)</sup>    | MAX                | MIN                | MAX                | MIN               | MAX                | UNIT |
| V <sub>IK</sub>                 |  | V <sub>CC</sub> = 4.5 V,   | I <sub>I</sub> = −18 mA                 |      |                       | -1.2               |                    | -1.2               |                   | -1.2               | V    |
|                                 | $V_{CC} = 4.5 V$ ,   |  | $I_{OH} = -3 \text{ mA}$                | 2.5  |                       |                    | 2.5                |                    | 2.5               |                    |      |
| .,                              | $V_{CC} = 5 V$   |  | $I_{OH} = -3 \text{ mA}$                | 3    |                       |                    | 3                  |                    | 3                 |                    | V    |
| $V_{OH}$                        |  | \/ 45\/  | $I_{OH} = -24 \text{ mA}$               | 2    |                       |                    | 2                  |                    |                   |                    | V    |
|                                 |  | V <sub>CC</sub> = 4.5 V  | $I_{OH} = -32 \text{ mA}$               | 2(2) |                       |                    |                    |                    | 2                 |                    |      |
|                                 |  | V 45.V   | I <sub>OL</sub> = 48 mA                 |      |                       | 0.55               |                    | 0.55               |                   |                    | V    |
| $V_{OL}$                        |  | $V_{CC} = 4.5 \text{ V}$   | I <sub>OL</sub> = 64 mA                 |      |                       | 0.55(2)            |                    |                    |                   | 0.55               | V    |
| V <sub>hys</sub>                |  |  |   |      | 100                   |                    |                    |                    |                   |                    | mV   |
|                                 | Control inputs   | $V_{CC} = 0 \text{ to } 5.5 \text{ V}, V_{I} = V_{CC}$                   | √ <sub>CC</sub> or GND                  |      |                       | ±1                 |                    | ±1                 |                   | ±1                 |      |
| I <sub>I</sub>                  | A or B<br>port   | V <sub>CC</sub> = 2.1 V to 5.5 V, V                                      | ' <sub>I</sub> = V <sub>CC</sub> or GND |      |                       | ±20 <sup>(2)</sup> |                    | ±100               |                   | ±20                | μΑ   |
| l <sub>OZPU</sub>               | 1  | $V_{CC} = 0 \text{ to } 2.1 \text{ V, } V_{O} =$                         | 0.5 V to 2.7 V, <del>OE</del> = X       |      |                       | ±50(3)             |                    | ±50 <sup>(3)</sup> |                   | ±50                | μΑ   |
| I <sub>OZPD</sub>               |  | $V_{CC} = 2.1 \text{ V to 0, } V_{O} =$                                  |   |      | ±50(3)                |                    | ±50 <sup>(3)</sup> |                    | ±50               | μΑ                 |      |
| I <sub>OZH</sub> <sup>(4)</sup> |  | $V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}, \text{ V}$                    |   |      | 10 <sup>(5)</sup>     |                    | 10                 |                    | 10 <sup>(5)</sup> | μΑ                 |      |
| I <sub>OZL</sub> <sup>(4)</sup> |  | $V_{CC}$ = 2.1 V to 5.5 V, $V_{O}$ = 0.5 V, OE $\geq$ 2 V                |   |      |                       | -10 <sup>(5)</sup> |                    | -10                |                   | -10 <sup>(5)</sup> | μΑ   |
| I <sub>off</sub>                |  | $V_{CC} = 0$ ,   | $V_I$ or $V_O \le 5.5 \text{ V}$        |      |                       | ±100               |                    |                    |                   | ±100               | μΑ   |
| I <sub>CEX</sub>                |  | V <sub>CC</sub> = 5.5 V,<br>V <sub>O</sub> = 5.5 V                       | Outputs high                            |      |                       | 50                 |                    | 50                 |                   | 50                 | μΑ   |
| I <sub>O</sub> <sup>(6)</sup>   |  | V <sub>CC</sub> = 5.5 V,   | V <sub>O</sub> = 2.5 V                  | -50  | -100                  | -180               | -50                | -180               | -50               | -180               | mA   |
|                                 | _  |  | Outputs high                            |      |                       | 2                  |                    | 2                  |                   | 2                  |      |
| $I_{CC}$                        | A or B<br>port   | $V_{CC} = 5.5 \text{ V}, I_{O} = 0,$<br>$V_{I} = V_{CC} \text{ or GND}$  | Outputs low                             |      |                       | 32                 |                    | 32                 |                   | 32                 | mA   |
|                                 | Port   | 1 100 0.15   | Outputs disabled                        |      |                       | 2                  |                    | 2                  |                   | 2                  |      |
|                                 |  | $V_{CC} = 5.5 \text{ V},$  | Outputs enabled                         |      |                       | 2                  |                    | 1.5                |                   | 2                  |      |
| Δl <sub>CC</sub> <sup>(7)</sup> | Data One inputs at 3.4 V, Other inputs at V <sub>CC</sub> or GND |  | Outputs disabled                        |      |                       | 0.05               |                    | 1                  |                   | 0.05               | mA   |
|                                 | Control inputs   | $V_{CC}$ = 5.5 V, One input at 3.4 V,<br>Other inputs at $V_{CC}$ or GND |   |      |                       | 1.5                |                    | 1.5                |                   | 1.5                |      |
| Ci                              | Control inputs   | V <sub>I</sub> = 2.5 V or 0.5 V  |   |      | 3                     |                    |                    |                    |                   |                    | pF   |
| C <sub>o</sub>                  | A or B<br>port   | V <sub>O</sub> = 2.5 V or 0.5 V  |   |      | 6                     |                    |                    |                    |                   |                    | pF   |

- All typical values are at  $V_{CC}$  = 5 V. On products compliant to MIL-PRF-38535, this parameter does not apply. On products compliant to MIL-PRF-38535, this parameter is not production tested.
- The parameters  $I_{\text{OZH}}$  and  $I_{\text{OZL}}$  include the input leakage current.
- This limit may vary among suppliers.
- (6) Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V<sub>CC</sub> or GND.

# SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300G-MARCH 1994-REVISED JANUARY 2006



## **Switching Characteristics**

over recommended operating ranges of supply voltage and operating free-air temperature,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

|                  |                 |                |                | SN54                                       | ABT162 | 45A |     | UNIT |
|------------------|-----------------|----------------|----------------|--|--------|-----|-----|------|
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>C</sub> | <sub>CC</sub> = 5 V <sub>A</sub><br>= 25°C | ,      | MIN | MAX |      |
|                  |                 |                | MIN            | TYP  | MAX    |     |     |      |
| t <sub>PLH</sub> | A or B          | B or A         | 0.5            | 2.2  | 3.4    | 0.5 | 4   | no   |
| t <sub>PHL</sub> | AUID            | BUIA           | 0.5            | 2.3  | 3.8    | 0.5 | 4.6 | ns   |
| t <sub>PZH</sub> | <del>OE</del>   | B or A         | 0.8            | 3.6  | 5.2    | 0.8 | 5.5 | no   |
| t <sub>PZL</sub> | OE              | BULA           | 0.9            | 3.7  | 6.1    | 0.1 | 7.3 | ns   |
| t <sub>PHZ</sub> | <del>OE</del>   | B or A         | 1.3            | 4.4  | 5.8    | 1.3 | 6.3 | ne   |
| t <sub>PLZ</sub> | OE .            | BULA           | 1.4            | 3.3  | 4.7    | 1.4 | 5.5 | ns   |

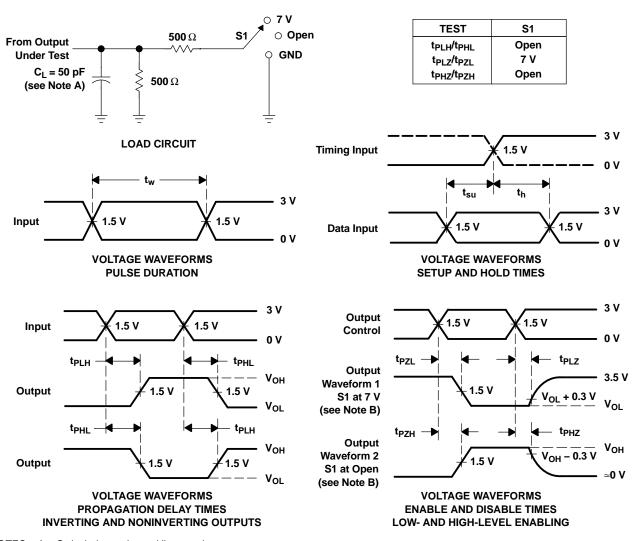
# **Switching Characteristics**

over recommended operating ranges of supply voltage and operating free-air temperature,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT)       |     | <sub>CC</sub> = 5 V <sub>A</sub><br>= 25°C |     | MIN | MAX | UNIT |
|------------------|-----------------|----------------------|-----|--|-----|-----|-----|------|
|                  |                 |                      | MIN | TYP  | MAX |     |     |      |
| t <sub>PLH</sub> | A or B          | B or A               | 1   | 2.2  | 3.4 | 1   | 3.9 | 2    |
| t <sub>PHL</sub> | AUID            | BULA                 | 1   | 2.3  | 3.7 | 1   | 4.2 | ns   |
| t <sub>PZH</sub> | <del>OE</del>   | B or A               | 1   | 3.6  | 5.2 | 1   | 6.3 | 20   |
| t <sub>PZL</sub> | OL              | BULK                 | 1   | 3.7  | 5.4 | 1   | 6.4 | ns   |
| t <sub>PHZ</sub> | <del>OE</del>   | <del>OE</del> B or A |     | 4.4  | 5.8 | 2   | 6.3 | ns   |
| t <sub>PLZ</sub> | OL              | BULA                 | 1.5 | 3.3  | 4.7 | 1.5 | 5.2 | 115  |



#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq 2.5$  ns.  $t_f \leq 2.5$  ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



5-Sep-2011

#### **PACKAGING INFORMATION**

| Orderable Device   | Status (1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|--------------------|------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| 5962-9317501MXA    | ACTIVE     | CFP          | WD                 | 48   | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 74ABT16245ADGGRG4  | ACTIVE     | TSSOP        | DGG                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| 74ABT16245ADGVRE4  | ACTIVE     | TVSOP        | DGV                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| 74ABT16245ADGVRG4  | ACTIVE     | TVSOP        | DGV                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT16245ADGGR  | ACTIVE     | TSSOP        | DGG                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT16245ADGVR  | ACTIVE     | TVSOP        | DGV                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT16245ADL    | ACTIVE     | SSOP         | DL                 | 48   | 25          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT16245ADLG4  | ACTIVE     | SSOP         | DL                 | 48   | 25          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT16245ADLR   | ACTIVE     | SSOP         | DL                 | 48   | 1000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT16245ADLRG4 | ACTIVE     | SSOP         | DL                 | 48   | 1000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SNJ54ABT16245AWD   | ACTIVE     | CFP          | WD                 | 48   | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



# PACKAGE OPTION ADDENDUM

5-Sep-2011

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL. Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN54ABT16245A, SN74ABT16245A:

Catalog: SN74ABT16245A

● Enhanced Product: SN74ABT16245A-EP, SN74ABT16245A-EP

Military: SN54ABT16245A

NOTE: Qualified Version Definitions:

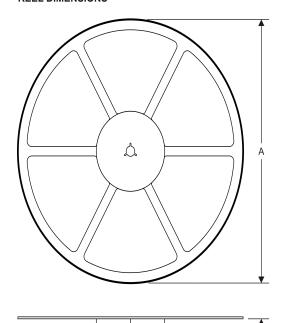
- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

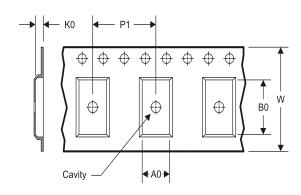
www.ti.com 14-Jul-2012

# TAPE AND REEL INFORMATION

#### **REEL DIMENSIONS**



#### **TAPE DIMENSIONS**



| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### TAPE AND REEL INFORMATION

#### \*All dimensions are nominal

| Device            | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ABT16245ADGGR | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 15.8       | 1.8        | 12.0       | 24.0      | Q1               |
| SN74ABT16245ADGVR | TVSOP           | DGV                | 48 | 2000 | 330.0                    | 16.4                     | 7.1        | 10.2       | 1.6        | 12.0       | 16.0      | Q1               |
| SN74ABT16245ADLR  | SSOP            | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |

www.ti.com 14-Jul-2012



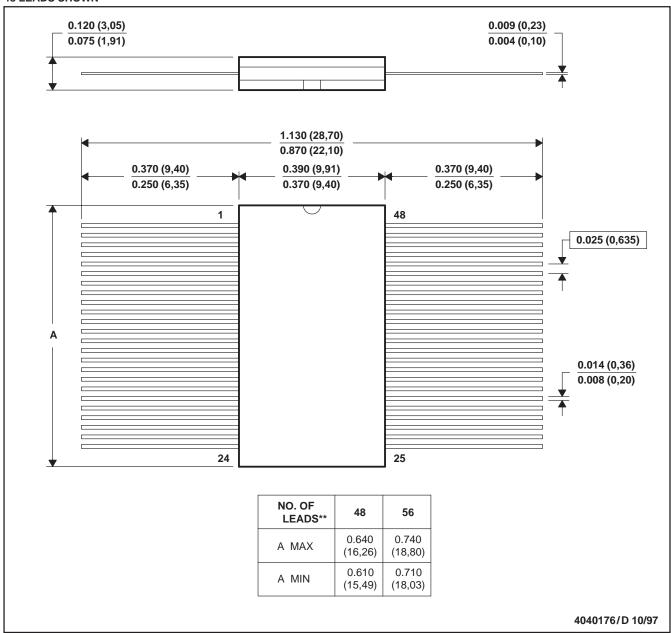
\*All dimensions are nominal

| 7 III GITTIOTIOTOTIO GITO TIOTITICA |              |                 |      |      |             |            |             |
|-------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                              | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74ABT16245ADGGR                   | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74ABT16245ADGVR                   | TVSOP        | DGV             | 48   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74ABT16245ADLR                    | SSOP         | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |

### WD (R-GDFP-F\*\*)

#### **CERAMIC DUAL FLATPACK**

#### **48 LEADS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only
- E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA

GDFP1-F56 and JEDEC MO-146AB

# DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

### DL (R-PDSO-G\*\*)

#### **48 PINS SHOWN**

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

# DGG (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46C and to discontinue any product or service per JESD48B. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

| roducts |                    | Applications  |
|---------|--------------------|---------------|
| udia    | ununu ti oom/oudio | Automotive on |

Audio Automotive and Transportation www.ti.com/automotive www.ti.com/audio www.ti.com/communications **Amplifiers** amplifier.ti.com Communications and Telecom **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical Logic logic.ti.com Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

OMAP Mobile Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity

www.ti-rfid.com

Pr



OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

#### Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный) Email: org@lifeelectronics.ru